

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HITACHI, LTD.	01/19/2023
RECEIVING PARTY DATA	
Name:	HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD.
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Internal Address:	CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	101-0021
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	10983013
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NAME OF SUBMITTER:	JOHN M. BOLLINGER
SIGNATURE:	/John M. Bollinger/
DATE SIGNED:	02/09/2023
Total Attachments: 2	
source=HITACHI11_111501919US01_P30109US1_Assignment_HitachiLtd_HitachiIndustrialEquipment_EFS#page1.tif	
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ASSIGNMENT

WHEREAS, Hitachi, Ltd., a corporation organized and existing under and by virtue of the laws of Japan, having an office at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, 100-8280, Japan, is the owner of the entire right, title, and interest in the U.S. Patent No. 10,983,013 (hereinafter referred to as "Patent"), issued on April 20, 2021 and entitled

TEMPERATURE SENSING BODY

in the United States by previous assignment.

WHEREAS, Hitachi Industrial Equipment Systems Co., Ltd., a corporation organized and existing under and by virtue of the laws of Japan, having an office at 1-5-1, Sotokanda, Chiyoda-ku, Tokyo 101-0021, Japan, is desirous of acquiring the entire right, title, and interest in and to the Patent.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, Hitachi, Ltd., intending to be legally bound, does hereby sell, assign, and transfer to Hitachi Industrial Equipment Systems Co., Ltd., its successors, assigns, and legal representatives the entire right, title, and interest in the Patent, including, but not limited to all divisions and continuations thereof in the United States, and in all letters patent in the United States, including all reissues and reexaminations thereof in the United States, and the right to sue parties other than Hitachi, Ltd. for past infringement.

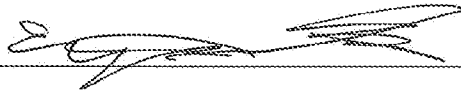
It is agreed that Hitachi, Ltd. shall be legally bound, upon request of Hitachi Industrial Equipment Systems Co., Ltd., to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the Patent for the benefit of Hitachi Industrial Equipment Systems Co., Ltd., and to execute all instruments proper to carry out the intent of this instrument.

Hitachi, Ltd. warrants that the rights and property herein conveyed are free and clear of any encumbrance.

EXECUTED under seal on this 19 day of January, 2023.

Hitachi, Ltd.,

By: _____



Eiji Sato

General Manager

IP Innovation Division

Global Intellectual Property Group

(Authorized Signing Officer)